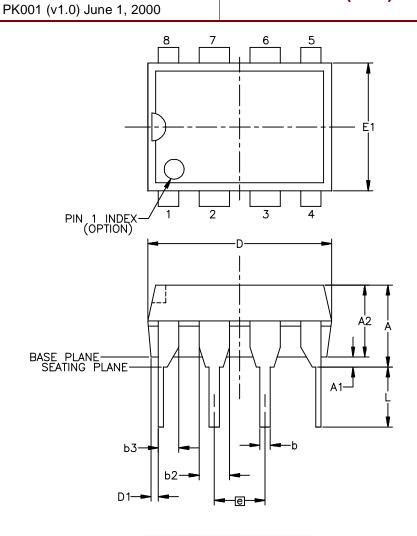
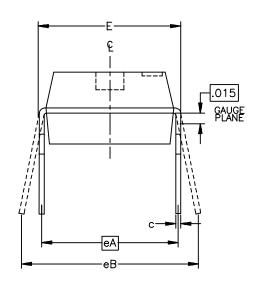
Plastic DIP (PD8) Package





| SYMBOL | INCHES | | N D T |
|----------------|-----------|-------|-------------|
| | MIN. | MAX. | Ę |
| Α | * | 0.181 | |
| A ₁ | 0.019 | × | |
| A2 | 0.122 | 0.161 | |
| b | 0.014 | 0.022 | |
| b2 | 0.045 | * | |
| ρЗ | ** | 0.045 | |
| c | 0.009 | 0.012 | |
| D | 0.355 | 0.382 | |
| D_1 | 0.005 | * | |
| E | 0.303 | 0.323 | |
| E ₁ | 0,240 | 0.272 | |
| e | 0.100 BSC | | |
| eA | 0.300 BSC | | |
| еB | * | 0.430 | |
| L | 0,115 | 0.150 | |
| N | 8 | | |

NOTES:

- 1. ALL DIMENSIONS AND TOLERANCES CONFORM TO ANSI Y14.5M-1982.
- 2. DIMENSIONS "D" AND "E1" DO NOT INCLUDE MOLD PROTRUSIONS. ALLOWABLE MOLD PROTRUSION SHALL NOT EXCEED .010" PER SIDE.
- 3. LEAD FINISH: (85±5%)Sn-Pb SOLDER PLATE
- 4. CONFORMS TO JEDEC MS-001-BA

8-PIN PLASTIC DIP (PD8)

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